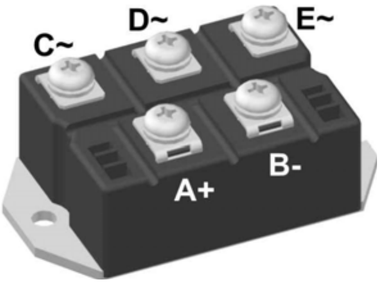
Standard Rectifier Module

3~ Rectifier		
V_{RRM}	=	1600 V
I_{DAV}	=	125 A
I_{FSM}	=	1200 A

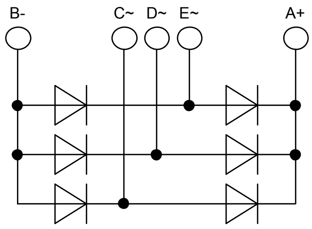
3~ Rectifier Bridge

Part number

VUO110-16NO7



UL E72873



Features / Advantages:

- Package with DCB ceramic
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current

Applications:

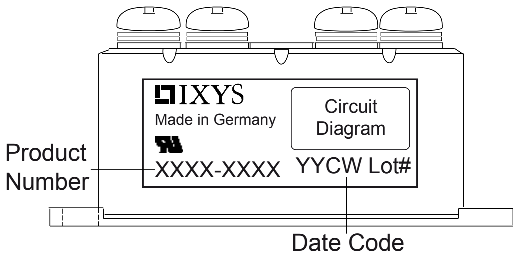
- Diode for main rectification
- For three phase bridge configurations
- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

Package: PWS-E

- Industry standard outline
- RoHS compliant
- Easy to mount with two screws
- Base plate: Copper internally DCB isolated
- Advanced power cycling

Rectifier				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V_{RSM}	*max. non-repetitive reverse blocking voltage*		T_{VJ} = 25°C			1700	V
V_{RRM}	*max. repetitive reverse blocking voltage*		T_{VJ} = 25°C			1600	V
I_R	*reverse current*	V_R = 1600 V	T_{VJ} = 25°C			100	µA
		V_R = 1600 V	T_{VJ} = 150°C			2	mA
V_F	*forward voltage drop*	I_F = 50 A	T_{VJ} = 25°C			1.13	V
		I_F = 150 A				1.46	V
		I_F = 50 A	T_{VJ} = 125 °C			1.04	V
		I_F = 150 A				1.47	V
I_{DAV}	*bridge output current*	T_C = 110°C rectangular d = ⅓	T_{VJ} = 150°C			125	A
V_{F0}	*threshold voltage*	*for power loss calculation only*	T_{VJ} = 150°C			0.79	V
r_F	*slope resistance*					4.5	mΩ
R_{thJC}	*thermal resistance junction to case*					0.7	K/W
R_{thCH}	*thermal resistance case to heatsink*				0.3		K/W
P_{tot}	*total power dissipation*		T_C = 25°C			175	W
I_{FSM}	*max. forward surge current*	t = 10 ms; (50 Hz), sine	T_{VJ} = 45°C			1.20	kA
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			1.30	kA
		t = 10 ms; (50 Hz), sine	T_{VJ} = 150°C			1.02	kA
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			1.10	kA
I^2t	*value for fusing*	t = 10 ms; (50 Hz), sine	T_{VJ} = 45°C			7.20	kA²s
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			6.98	kA²s
		t = 10 ms; (50 Hz), sine	T_{VJ} = 150°C			5.20	kA²s
		t = 8,3 ms; (60 Hz), sine	V_R = 0 V			5.04	kA²s
C_J	*junction capacitance*	V_R = 400 V; f = 1 MHz	T_{VJ} = 25°C		37		pF

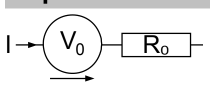
Package PWS-E				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
I_{RMS}	*RMS current*	per terminal				200	A
T_{stg}	*storage temperature*			-40		125	°C
T_{VJ}	*virtual junction temperature*			-40		150	°C
Weight					284		g
M_D	*mounting torque*			4.25		5.75	Nm
M_T	*terminal torque*			4.25		5.75	Nm
$d_{Spp/App}$	*creepage distance on surface | striking distance through air*		*terminal to terminal*	12.0			mm
$d_{Spb/Apb}$			*terminal to backside*	26.0			mm
V_{ISOL}	*isolation voltage*	t = 1 second	50/60 Hz, RMS; I_{ISOL} ≤ 1 mA	3000			V
		t = 1 minute		2500			V



Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	VUO110-16NO7	VUO110-16NO7	Box	5	462403

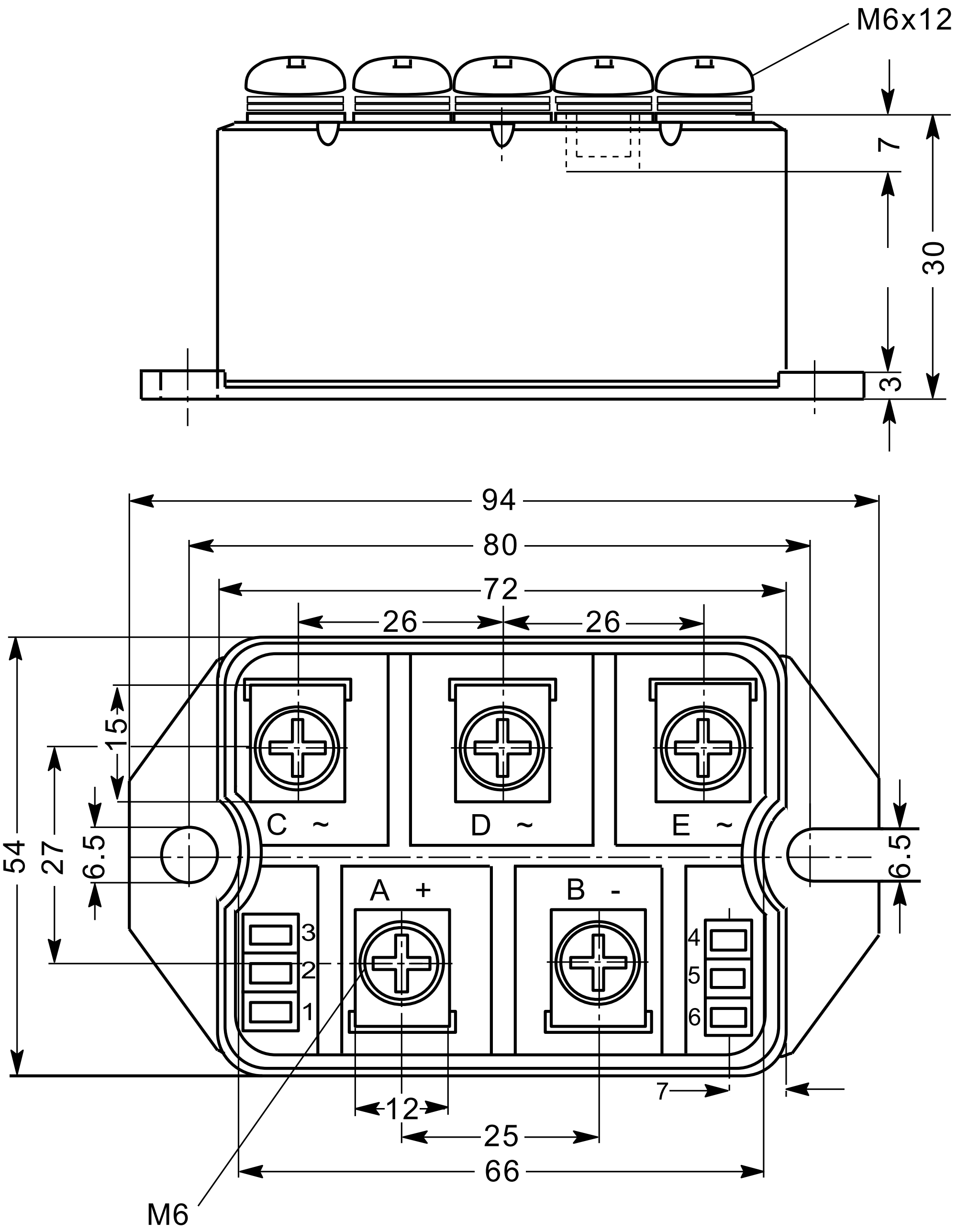
Equivalent Circuits for Simulation

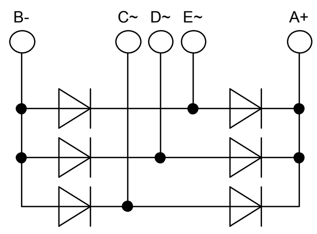
** on die level* $T_{VJ} = 150\,°C$



		Rectifier	
$V_{0\,max}$	*threshold voltage*	0.79	V
$R_{0\,max}$	*slope resistance **	3.3	mΩ

Outlines PWS-E





Rectifier

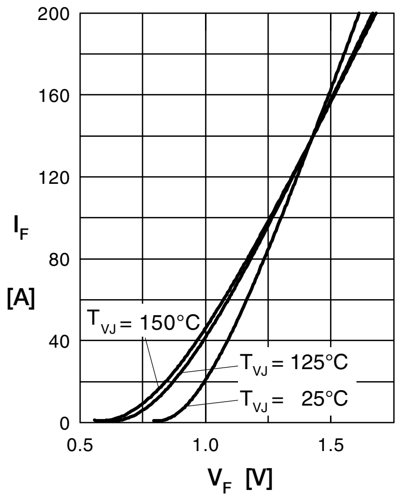


Fig. 1 Forward current vs. voltage drop per diode

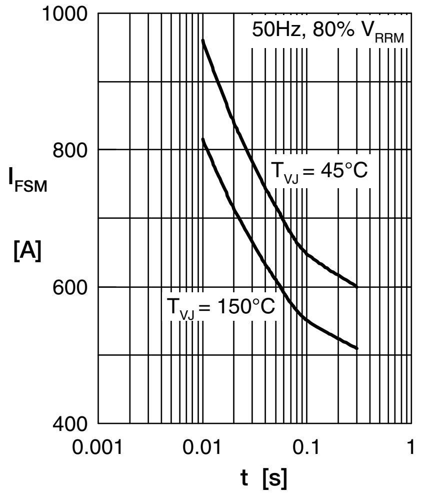


Fig. 2 Surge overload current vs. time per diode

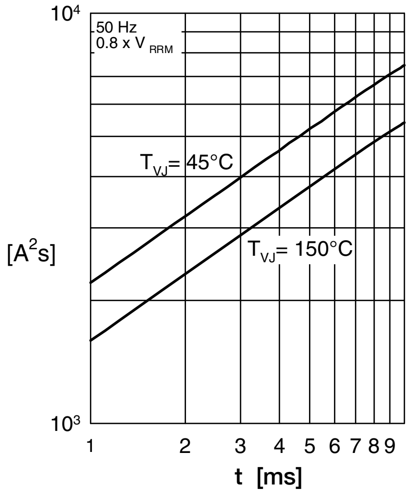


Fig. 3 I^2t vs. time per diode

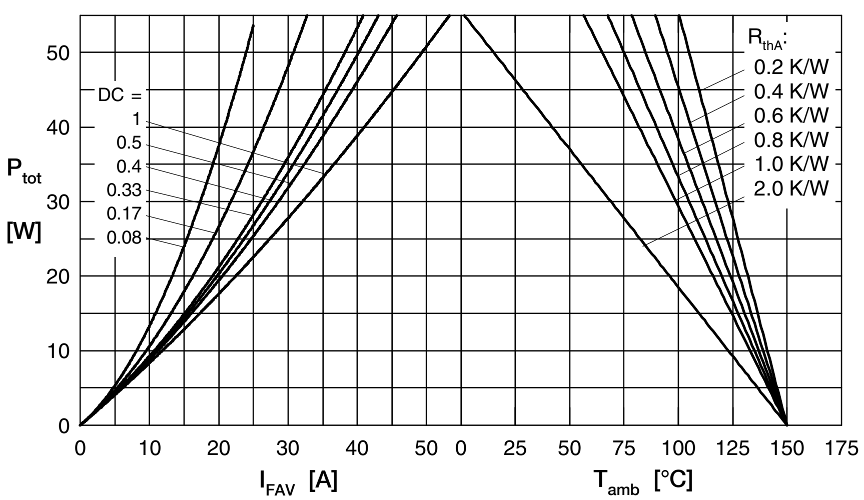


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

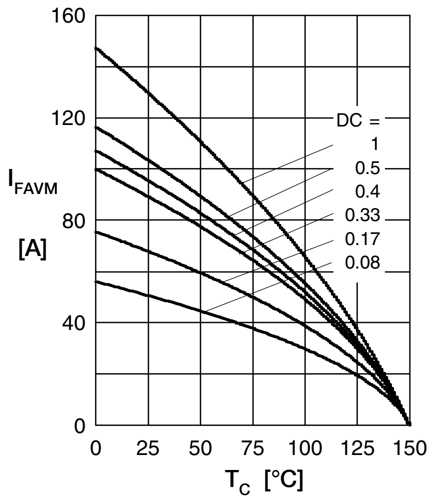
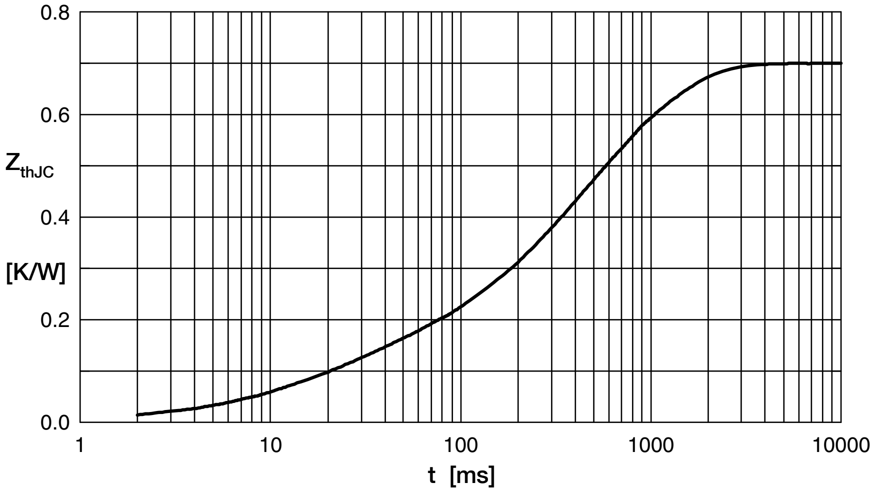


Fig. 5 Max. forward current vs. case temperature per diode



R_i	t_i
0.100	0.020
0.010	0.010
0.162	0.225
0.258	0.800
0.170	0.580

Fig. 6 Transient thermal impedance junction to case vs. time per diode